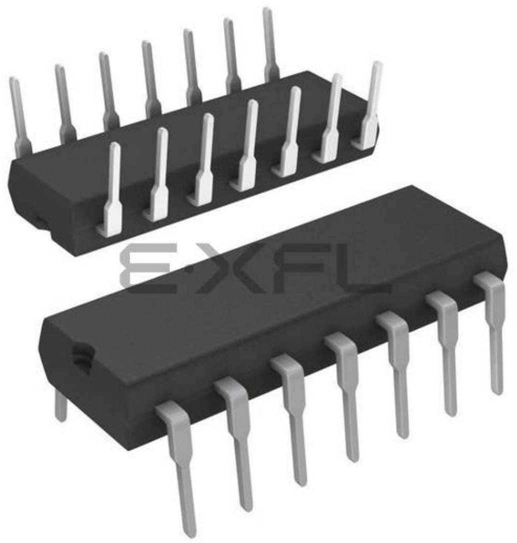

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	12
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 11x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	14-DIP (0.300", 7.62mm)
Supplier Device Package	14-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f15323-e-p

4.0 MEMORY ORGANIZATION

These devices contain the following types of memory:

- Program Memory
  - Configuration Words
  - Device ID
  - User ID
  - Program Flash Memory
  - Device Information Area (DIA)
  - Device Configuration Information (DCI)
  - Revision ID
- Data Memory
  - Core Registers
  - Special Function Registers
  - General Purpose RAM
  - Common RAM

The following features are associated with access and control of program memory and data memory:

- PCL and PCLATH
- Stack
- Indirect Addressing
- NVMREG access

4.1 Program Memory Organization

The enhanced mid-range core has a 15-bit program counter capable of addressing 32K x 14 program memory space. Table 4-1 shows the memory sizes implemented. The Reset vector is at 0000h and the interrupt vector is at 0004h (see Figure 4-1).

TABLE 4-1: DEVICE SIZES AND ADDRESSES

Device	Program Memory Size (Words)	Last Program Memory Address
PIC16(L)F15313/23	2048	07FFh

TABLE 4-4: PIC16(L)F15313/23 MEMORY MAP, BANKS 0-7

BANK 0		BANK 1		BANK 2		BANK 3		BANK 4		BANK 5		BANK 6		BANK 7	
000h–00Bh	Core Register (Table 4-3)	080h–08Bh	Core Register (Table 4-3)	100h–10Bh	Core Register (Table 4-3)	180h–18Bh	Core Register (Table 4-3)	200h–20Bh	Core Register (Table 4-3)	280h–28Bh	Core Register (Table 4-3)	300h–30Bh	Core Register (Table 4-3)	380h–38Bh	Core Register (Table 4-3)
00Ch	PORTA	08Ch	—	10Ch	—	18Ch	SSP1BUF	20Ch	TMR1L	28Ch	TMR2	30Ch	CCPR1L	38Ch	PWM6DCL
00Dh	—	08Dh	—	10Dh	—	18Dh	SSP1ADD	20Dh	TMR1H	28Dh	PR2	30Dh	CCPR1H	38Dh	PWM6DCH
00Eh	PORTC(2)	08Eh	—	10Eh	—	18Eh	SSP1MASK	20Eh	T1CON	28Eh	T2CON	30Eh	CCP1CON	38Eh	PWM6CON
00Fh	—	08Fh	—	10Fh	—	18Fh	SSP1STAT	20Fh	T1GCON	28Fh	T2HLT	30Fh	CCP1CAP	38Fh	—
010h	—	090h	—	110h	—	190h	SSP1CON1	210h	T1GATE	290h	T2CLK	310h	CCPR2L	390h	—
011h	—	091h	—	111h	—	191h	SSP1CON2	211h	T1CLK	291h	T2ERS	311h	CCPR2H	391h	—
012h	TRISA	092h	—	112h	—	192h	SSP1CON3	212h	—	292h	—	312h	CCP2CON	392h	—
013h	—	093h	—	113h	—	193h	—	213h	—	293h	—	313h	CCP2CAP	393h	—
014h	TRISC(2)	094h	—	114h	—	194h	—	214h	—	294h	—	314h	PWM3DCL	394h	—
015h	—	095h	—	115h	—	195h	—	215h	—	295h	—	315h	PWM3DCH	395h	—
016h	—	096h	—	116h	—	196h	—	216h	—	296h	—	316h	PWM3CON	396h	—
017h	—	097h	—	117h	—	197h	—	217h	—	297h	—	317h	—	397h	—
018h	LATA	098h	—	118h	—	198h	—	218h	—	298h	—	318h	PWM4DCL	398h	—
019h	—	099h	—	119h	RC1REG1	199h	—	219h	—	299h	—	319h	PWM4DCH	399h	—
01Ah	LATC(2)	09Ah	—	11Ah	TX1REG1	19Ah	—	21Ah	—	29Ah	—	31Ah	PWM4CON	39Ah	—
01Bh	—	09Bh	ADRESL	11Bh	SP1BRG1L	19Bh	—	21Bh	—	29Bh	—	31Bh	—	39Bh	—
01Ch	—	09Ch	ADRESH	11Ch	SP1BRG1H	19Ch	—	21Ch	—	29Ch	—	31Ch	PWM5DCL	39Ch	—
01Dh	—	09Dh	ADCON0	11Dh	RC1STA1	19Dh	—	21Dh	—	29Dh	—	31Dh	PWM5DCH	39Dh	—
01Eh	—	09Eh	ADCON1	11Eh	TX1STA1	19Eh	—	21Eh	—	29Eh	—	31Eh	PWM5CON	39Eh	—
01Fh	—	09Fh	ADACT	11Fh	BAUD1CON1	19Fh	—	21Fh	—	29Fh	—	31Fh	—	39Fh	—
020h–07Fh	General Purpose Register 96 Bytes	0A0h–0EFh	General Purpose Register 80 Bytes	120h–16Fh	General Purpose Register 80 Bytes	1A0h–1EFh	Unimplemented Read as '0'	220h–26Fh	Unimplemented Read as '0'	2A0h–2EFh	Unimplemented Read as '0'	320h 32Fh 330h 36Fh	Unimplemented Read as '0'	3A0h–3EFh	Unimplemented Read as '0'
		0F0h–0FFh	Common RAM Accesses 70h-7Fh	170h–17Fh	Common RAM Accesses 70h-7Fh	1F0h–1FFh	Common RAM Accesses 70h-7Fh	270h–27Fh	Common RAM Accesses 70h-7Fh	2F0h–2FFh	Common RAM Accesses 70h-7Fh	370h–37Fh	Common RAM Accesses 70h-7Fh	3F0h–3FFh	Common RAM Accesses 70h-7Fh

Note 1: Unimplemented locations read as '0'.

2: Present only in PIC16(L)F15323.

REGISTER 10-2: PIE0: PERIPHERAL INTERRUPT ENABLE REGISTER 0

U-0	U-0	R/W-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0
—	—	TMR0IE	IOCIE	—	—	—	INTE
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	HS = Hardware set

bit 7-6 **Unimplemented**: Read as ‘0’

bit 5 **TMR0IE:** Timer0 Overflow Interrupt Enable bit
- 1 = Enables the Timer0 interrupt
- 0 = Disables the Timer0 interrupt

bit 4 **IOCIE:** Interrupt-on-Change Interrupt Enable bit
- 1 = Enables the IOC change interrupt
- 0 = Disables the IOC change interrupt

bit 3-1 **Unimplemented**: Read as ‘0’

bit 0 **INTE:** INT External Interrupt Flag bit(1)
- 1 = Enables the INT external interrupt
- 0 = Disables the INT external interrupt

Note 1: The External Interrupt GPIO pin is selected by INTPPS (Register 15-1).

Note:	Bit PEIE of the INTCON register must be set to enable any peripheral interrupt controlled by PIE1-PIE7. Interrupt sources controlled by the PIE0 register do not require PEIE to be set in order to allow interrupt vectoring (when GIE is set).

REGISTER 10-12: PIR2: PERIPHERAL INTERRUPT REQUEST REGISTER 2

U-0	R/W/HS-0/0	U-0	U-0	U-0	U-0	R/W/HS-0/0	R/W/HS-0/0
—	ZCDIF	—	—	—	—	C2IF(1)	C1IF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	HS = Hardware set

bit 7 **Unimplemented**: Read as ‘0’

bit 6 **ZCDIF:** Zero-Cross Detect (ZCD1) Interrupt Flag bit
1 = An enabled rising and/or falling ZCD1 event has been detected (must be cleared in software)
0 = No ZCD1 event has occurred

bit 5-2 **Unimplemented**: Read as ‘0’

bit 1 **C2IF**: Comparator C2 Interrupt Flag bit
1 = Comparator 2 interrupt asserted (must be cleared in software)
0 = Comparator 2 interrupt not asserted

bit 0 **C1IF:** Comparator C1 Interrupt Flag bit
1 = Comparator 1 interrupt asserted (must be cleared in software)
0 = Comparator 1 interrupt not asserted

Note 1: Present only on PIC16(L)F15323.

Note:	Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 20-4: ADRESH: ADC RESULT REGISTER HIGH (ADRESH) ADFM = 0

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
ADRES<9:2>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ADRES<9:2>**: ADC Result Register bits
Upper eight bits of 10-bit conversion result

REGISTER 20-5: ADRESL: ADC RESULT REGISTER LOW (ADRESL) ADFM = 0

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
ADRES<1:0>		—	—	—	—	—	—
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **ADRES<1:0>**: ADC Result Register bits
Lower two bits of 10-bit conversion result

bit 5-0 **Reserved**: Do not use.

TABLE 21-1: SUMMARY OF REGISTERS ASSOCIATED WITH THE DAC1 MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
DAC1CON0	DAC1EN	—	DAC1OE1	DAC1OE2	DAC1PSS<1:0>		—	DAC1NSS	232
DAC1CON1	—	—	—	DAC1R<4:0>					232
CM1PSEL	—	—	—	—	—	PCH<2:0>			252
CM2PSEL[(1)]	—	—	—	—	—	PCH<2:0>			252

Legend: — = Unimplemented location, read as ‘0’. Shaded cells are not used with the DAC module.

Note 1: Present on PIC16(L)F15323 only.

23.2 Comparator Control

Each comparator has two control registers: CMxCON0 and CMxCON1.

The CMxCON0 register (see Register 23-1) contains Control and Status bits for the following:

- Enable
- Output
- Output polarity
- Hysteresis enable
- Timer1 output synchronization

The CMxCON1 register (see Register 23-2) contains Control bits for the following:

- Interrupt on positive/negative edge enables
- The CMxNSEL and CMxPSEL (Register 23-3 and Register 23-4) contain control bits for the following:
  - Positive input channel selection
  - Negative input channel selection

23.2.1 COMPARATOR ENABLE

Setting the CxON bit of the CMxCON0 register enables the comparator for operation. Clearing the CxON bit disables the comparator resulting in minimum current consumption.

23.2.2 COMPARATOR OUTPUT

The output of the comparator can be monitored by reading either the CxOUT bit of the CMxCON0 register or the MCxOUT bit of the CMOUT register.

The comparator output can also be routed to an external pin through the RxyPPS register (Register 15-2). The corresponding TRIS bit must be clear to enable the pin as an output.

> **Note 1:** The internal output of the comparator is latched with each instruction cycle. Unless otherwise specified, external outputs are not latched.

23.2.3 COMPARATOR OUTPUT POLARITY

Inverting the output of the comparator is functionally equivalent to swapping the comparator inputs. The polarity of the comparator output can be inverted by setting the CxPOL bit of the CMxCON0 register. Clearing the CxPOL bit results in a non-inverted output.

Table 23-2 shows the output state versus input conditions, including polarity control.

TABLE 23-2: COMPARATOR OUTPUT STATE VS. INPUT CONDITIONS

Input Condition	CxPOL	CxOUT
CxVN > CxVP	0	0
CxVN < CxVP	0	1
CxVN > CxVP	1	1
CxVN < CxVP	1	0

REGISTER 26-2: T1GCON: TIMER1 GATE CONTROL REGISTER

R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u	R/W/HC-0/u	R-x/x	U-0	U-0
GE	GPOL	GTM	GSPM	GGO/$\overline{\text{DONE}}$	GVAL	—	—
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HC = Bit is cleared by hardware

bit 7 **GE:** Timer1 Gate Enable bit
If ON = 0:
This bit is ignored
If ON = 1:
1 = Timer1 counting is controlled by the Timer1 gate function
0 = Timer1 is always counting

bit 6 **GPOL:** Timer1 Gate Polarity bit
1 = Timer1 gate is active-high (Timer1 counts when gate is high)
0 = Timer1 gate is active-low (Timer1 counts when gate is low)

bit 5 **GTM:** Timer1 Gate Toggle Mode bit
1 = Timer1 Gate Toggle mode is enabled
0 = Timer1 Gate Toggle mode is disabled and toggle flip-flop is cleared
Timer1 gate flip-flop toggles on every rising edge.

bit 4 **GSPM:** Timer1 Gate Single-Pulse Mode bit
1 = Timer1 Gate Single-Pulse mode is enabled
0 = Timer1 Gate Single-Pulse mode is disabled

bit 3 **GGO/$\overline{\text{DONE}}$:** Timer1 Gate Single-Pulse Acquisition Status bit
1 = Timer1 gate single-pulse acquisition is ready, waiting for an edge
0 = Timer1 gate single-pulse acquisition has completed or has not been started
This bit is automatically cleared when GSPM is cleared

bit 2 **GVAL:** Timer1 Gate Value Status bit
Indicates the current state of the Timer1 gate that could be provided to TMR1H:TMR1L
Unaffected by Timer1 Gate Enable (GE)

bit 1-0 **Unimplemented:** Read as '0'

REGISTER 29-2: PWMxDCH: PWM DUTY CYCLE HIGH BITS

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
PWMxDC<9:2>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **PWMxDC<9:2>:** PWM Duty Cycle Most Significant bits
These bits are the MSbs of the PWM duty cycle. The two LSbs are found in PWMxDCL Register.

REGISTER 29-3: PWMxDCL: PWM DUTY CYCLE LOW BITS

R/W-x/u	R/W-x/u	U-0	U-0	U-0	U-0	U-0	U-0
PWMxDC<1:0>		—	—	—	—	—	—
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **PWMxDC<1:0>:** PWM Duty Cycle Least Significant bits
These bits are the LSbs of the PWM duty cycle. The MSbs are found in PWMxDCH Register.

bit 5-0 **Unimplemented:** Read as ‘0’

REGISTER 31-2: CLCxPOL: SIGNAL POLARITY CONTROL REGISTER

R/W-0/0	U-0	U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
LCxPOL	—	—	—	LCxG4POL	LCxG3POL	LCxG2POL	LCxG1POL
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **LCxPOL:** CLCxOUT Output Polarity Control bit
1 = The output of the logic cell is inverted
0 = The output of the logic cell is not inverted

bit 6-4 **Unimplemented:** Read as ‘0’

bit 3 **LCxG4POL:** Gate 3 Output Polarity Control bit
1 = The output of gate 3 is inverted when applied to the logic cell
0 = The output of gate 3 is not inverted

bit 2 **LCxG3POL:** Gate 2 Output Polarity Control bit
1 = The output of gate 2 is inverted when applied to the logic cell
0 = The output of gate 2 is not inverted

bit 1 **LCxG2POL:** Gate 1 Output Polarity Control bit
1 = The output of gate 1 is inverted when applied to the logic cell
0 = The output of gate 1 is not inverted

bit 0 **LCxG1POL:** Gate 0 Output Polarity Control bit
1 = The output of gate 0 is inverted when applied to the logic cell
0 = The output of gate 0 is not inverted

32.3.1 CLOCK STRETCHING

When a slave device has not completed processing data, it can delay the transfer of more data through the process of clock stretching. An addressed slave device may hold the SCL clock line low after receiving or sending a bit, indicating that it is not yet ready to continue. The master that is communicating with the slave will attempt to raise the SCL line in order to transfer the next bit, but will detect that the clock line has not yet been released. Because the SCL connection is open-drain, the slave has the ability to hold that line low until it is ready to continue communicating.

Clock stretching allows receivers that cannot keep up with a transmitter to control the flow of incoming data.

32.3.2 ARBITRATION

Each master device must monitor the bus for Start and Stop bits. If the device detects that the bus is busy, it cannot begin a new message until the bus returns to an Idle state.

However, two master devices may try to initiate a transmission on or about the same time. When this occurs, the process of arbitration begins. Each transmitter checks the level of the SDA data line and compares it to the level that it expects to find. The first transmitter to observe that the two levels do not match, loses arbitration, and must stop transmitting on the SDA line.

For example, if one transmitter holds the SDA line to a logical one (lets it float) and a second transmitter holds it to a logical zero (pulls it low), the result is that the SDA line will be low. The first transmitter then observes that the level of the line is different than expected and concludes that another transmitter is communicating.

The first transmitter to notice this difference is the one that loses arbitration and must stop driving the SDA line. If this transmitter is also a master device, it also must stop driving the SCL line. It then can monitor the lines for a Stop condition before trying to reissue its transmission. In the meantime, the other device that has not noticed any difference between the expected and actual levels on the SDA line continues with its original transmission.

Slave Transmit mode can also be arbitrated, when a master addresses multiple slaves, but this is less common.

32.4 I^{2}C MODE OPERATION

All MSSP I^{2}C communication is byte oriented and shifted out MSb first. Six SFR registers and two interrupt flags interface the module with the PIC® microcontroller and user software. Two pins, SDA and SCL, are exercised by the module to communicate with other external I^{2}C devices.

32.4.1 BYTE FORMAT

All communication in I^{2}C is done in 9-bit segments. A byte is sent from a master to a slave or vice-versa, followed by an Acknowledge bit sent back. After the eighth falling edge of the SCL line, the device outputting data on the SDA changes that pin to an input and reads in an acknowledge value on the next clock pulse.

The clock signal, SCL, is provided by the master. Data is valid to change while the SCL signal is low, and sampled on the rising edge of the clock. Changes on the SDA line while the SCL line is high define special conditions on the bus, explained below.

32.4.2 DEFINITION OF I^{2}C TERMINOLOGY

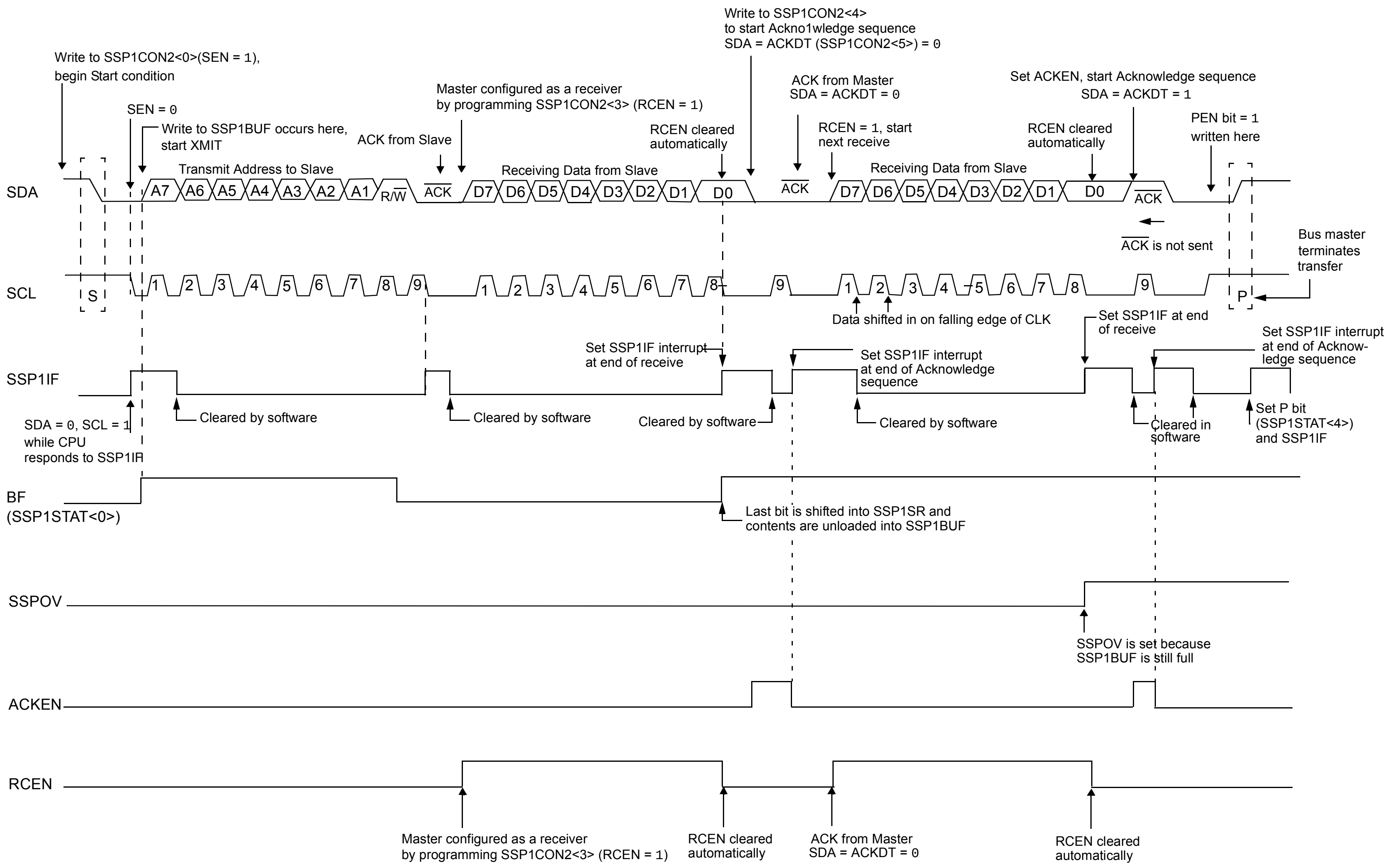
There is language and terminology in the description of I^{2}C communication that have definitions specific to I^{2}C. That word usage is defined below and may be used in the rest of this document without explanation. This table was adapted from the Philips I^{2}C specification.

32.4.3 SDA AND SCL PINS

Selection of any I^{2}C mode with the SSPEN bit set, forces the SCL and SDA pins to be open-drain. These pins should be set by the user to inputs by setting the appropriate TRIS bits.

Note 1:	Any device pin can be selected for SDA and SCL functions with the PPS peripheral. These functions are bidirectional. The SDA input is selected with the SSPDATPPS registers. The SCL input is selected with the SSPCLKPPS registers. Outputs are selected with the RxyPPS registers. It is the user's responsibility to make the selections so that both the input and the output for each function is on the same pin.

FIGURE 32-29: I²C MASTER MODE WAVEFORM (RECEPTION, 7-BIT ADDRESS)



Preliminary

32.7 BAUD RATE GENERATOR

The MSSP module has a Baud Rate Generator available for clock generation in both I²C and SPI Master modes. The Baud Rate Generator (BRG) reload value is placed in the SSP1ADD register (Register 32-6). When a write occurs to SSP1BUF, the Baud Rate Generator will automatically begin counting down.

Once the given operation is complete, the internal clock will automatically stop counting and the clock pin will remain in its last state.

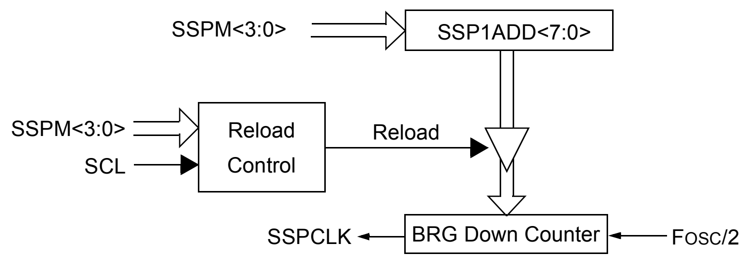
An internal signal "Reload" in Figure 32-40 triggers the value from SSP1ADD to be loaded into the BRG counter. This occurs twice for each oscillation of the module clock line. The logic dictating when the reload signal is asserted depends on the mode the MSSP is being operated in.

Table 32-4 demonstrates clock rates based on instruction cycles and the BRG value loaded into SSP1ADD.

EQUATION 32-1:

$$F_{CLOCK} = \frac{F_{OSC}}{(SSP1ADD + 1)(4)}$$

FIGURE 32-40: BAUD RATE GENERATOR BLOCK DIAGRAM



Note:	Values of `0x00`, `0x01` and `0x02` are not valid for SSP1ADD when used as a Baud Rate Generator for I²C. This is an implementation limitation.

TABLE 32-2: MSSP CLOCK RATE W/BRG

FOSC	FCY	BRG Value	FCLOCK (2 Rollovers of BRG)
32 MHz	8 MHz	13h	400 kHz
32 MHz	8 MHz	19h	308 kHz
32 MHz	8 MHz	4Fh	100 kHz
16 MHz	4 MHz	09h	400 kHz
16 MHz	4 MHz	0Ch	308 kHz
16 MHz	4 MHz	27h	100 kHz
4 MHz	1 MHz	09h	100 kHz

Note: Refer to the I/O port electrical specifications in Table 37-4 to ensure the system is designed to support I_{OL} requirements.

33.2 Clock Accuracy with Asynchronous Operation

The factory calibrates the internal oscillator block output (INTOSC). However, the INTOSC frequency may drift as V_{DD} or temperature changes, and this directly affects the asynchronous baud rate. Two methods may be used to adjust the baud rate clock, but both require a reference clock source of some kind.

The first (preferred) method uses the OSCTUNE register to adjust the INTOSC output. Adjusting the value in the OSCTUNE register allows for fine resolution changes to the system clock source. See **Section 9.2.2.2 "Internal Oscillator Frequency Adjustment"** for more information.

The other method adjusts the value in the Baud Rate Generator. This can be done automatically with the Auto-Baud Detect feature (see **Section 33.3.1 "Auto-Baud Detect"**). There may not be fine enough resolution when adjusting the Baud Rate Generator to compensate for a gradual change in the peripheral clock frequency.

TABLE 36-3: INSTRUCTION SET (CONTINUED)

Mnemonic, Operands		Description	Cycles	14-Bit Opcode MSb			LSb	Status Affected	Notes
CONTROL OPERATIONS									
BRA	k	Relative Branch	2	11	001k	kkkk	kkkk		
BRW	–	Relative Branch with W	2	00	0000	0000	1011		
CALL	k	Call Subroutine	2	10	0kkk	kkkk	kkkk		
CALLW	–	Call Subroutine with W	2	00	0000	0000	1010		
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
RETFIE	k	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	0100	kkkk	kkkk		
RETURN	–	Return from Subroutine	2	00	0000	0000	1000		
INHERENT OPERATIONS									
CLRWDT	–	Clear Watchdog Timer	1	00	0000	0110	0100	$\overline{TO}$, $\overline{PD}$	
NOP	–	No Operation	1	00	0000	0000	0000		
RESET	–	Software device Reset	1	00	0000	0000	0001		
SLEEP	–	Go into Standby or IDLE mode	1	00	0000	0110	0011	$\overline{TO}$, $\overline{PD}$	
TRIS	f	Load TRIS register with W	1	00	0000	0110	0fff		
C-COMPILER OPTIMIZED									
ADDFSR	n, k	Add Literal k to FSRn	1	11	0001	0nkk	kkkk		
MOVIW	n mm	Move Indirect FSRn to W with pre/post inc/dec modifier, mm	1	00	0000	0001	0nmm	Z	**2, 3**
	k[n]	Move INDFn to W, Indexed Indirect.	1	11	1111	0nkk	kkkk	Z	**2**
MOVWI	n mm	Move W to Indirect FSRn with pre/post inc/dec modifier, mm	1	00	0000	0001	1nmm		**2, 3**
	k[n]	Move W to INDFn, Indexed Indirect.	1	11	1111	1nkk	kkkk		**2**

Note 1: If the Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a `NOP`.

2: If this instruction addresses an INDF register and the MSb of the corresponding FSR is set, this instruction will require one additional instruction cycle.

3: See Table in the MOVIW and MOVWI instruction descriptions.

CALL — Call Subroutine

Syntax:	[*label*] CALL k
Operands:	$0 \leq k \leq 2047$
Operation:	(PC)+ 1→ TOS, k → PC<10:0>, (PCLATH<6:3>) → PC<14:11>
Status Affected:	None
Description:	Call Subroutine. First, return address (PC + 1) is pushed onto the stack. The 11-bit immediate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. `CALL` is a 2-cycle instruction.

CALLW — Subroutine Call With W

Syntax:	[*label*] CALLW
Operands:	None
Operation:	(PC) +1 → TOS, (W) → PC<7:0>, (PCLATH<6:0>) → PC<14:8>
Status Affected:	None
Description:	Subroutine call with W. First, the return address (PC + 1) is pushed onto the return stack. Then, the contents of W is loaded into PC<7:0>, and the contents of PCLATH into PC<14:8>. `CALLW` is a 2-cycle instruction.

CLRF — Clear f

Syntax:	[*label*] CLRF f
Operands:	$0 \leq f \leq 127$
Operation:	00h → (f) 1 → Z
Status Affected:	Z
Description:	The contents of register ‘f’ are cleared and the Z bit is set.

CLRW — Clear W

Syntax:	[*label*] CLRW
Operands:	None
Operation:	00h → (W) 1 → Z
Status Affected:	Z
Description:	W register is cleared. Zero bit (Z) is set.

CLRWDT — Clear Watchdog Timer

Syntax:	[*label*] CLRWDT
Operands:	None
Operation:	00h → WDT 0 → WDT prescaler, 1 → $\overline{TO}$ 1 → $\overline{PD}$
Status Affected:	$\overline{TO}$, $\overline{PD}$
Description:	`CLRWDT` instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. Status bits $\overline{TO}$ and $\overline{PD}$ are set.

COMF — Complement f

Syntax:	[*label*] COMF f,d
Operands:	$0 \leq f \leq 127$ d ∈ [0,1]
Operation:	$(\overline{f})$ → (destination)
Status Affected:	Z
Description:	The contents of register ‘f’ are complemented. If ‘d’ is ‘0’, the result is stored in W. If ‘d’ is ‘1’, the result is stored back in register ‘f’.

DECF — Decrement f

Syntax:	[*label*] DECF f,d
Operands:	$0 \leq f \leq 127$ d ∈ [0,1]
Operation:	(f) - 1 → (destination)
Status Affected:	Z
Description:	Decrement register ‘f’. If ‘d’ is ‘0’, the result is stored in the W register. If ‘d’ is ‘1’, the result is stored back in register ‘f’.

MOVWI — Move W to INDFn

Syntax: [*label*] MOVWI ++FSRn
[*label*] MOVWI --FSRn
[*label*] MOVWI FSRn++
[*label*] MOVWI FSRn--
[*label*] MOVWI k[FSRn]

Operands: n ∈ [0,1]
mm ∈ [00,01, 10, 11]
-32 ≤ k ≤ 31

Operation: W → INDFn
Effective address is determined by
- FSR + 1 (preincrement)
- FSR - 1 (predecrement)
- FSR + k (relative offset)

After the Move, the FSR value will be either:
- FSR + 1 (all increments)
- FSR - 1 (all decrements)

Unchanged

Status Affected: None

Mode	Syntax	mm
Preincrement	++FSRn	00
Predecrement	--FSRn	01
Postincrement	FSRn++	10
Postdecrement	FSRn--	11

Description: This instruction is used to move data between W and one of the indirect registers (INDFn). Before/after this move, the pointer (FSRn) is updated by pre/post incrementing/decrementing it.

Note: The INDFn registers are not physical registers. Any instruction that accesses an INDFn register actually accesses the register at the address specified by the FSRn.

FSRn is limited to the range 0000h-FFFFh. Incrementing/decrementing it beyond these bounds will cause it to wrap-around.

The increment/decrement operation on FSRn WILL NOT affect any Status bits.

NOP — No Operation

Syntax: [*label*] NOP

Operands: None

Operation: No operation

Status Affected: None

Description: No operation.

Words: 1

Cycles: 1

Example: `NOP`

RESET — Software Reset

Syntax: [*label*] RESET

Operands: None

Operation: Execute a device Reset. Resets the $\overline{\text{RI}}$ flag of the PCON register.

Status Affected: None

Description: This instruction provides a way to execute a hardware Reset by software.

RETFIE — Return from Interrupt

Syntax: [*label*] RETFIE k

Operands: None

Operation: TOS → PC,
1 → GIE

Status Affected: None

Description: Return from Interrupt. Stack is POPed and Top-of-Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a 2-cycle instruction.

Words: 1

Cycles: 2

Example: `RETFIE`

After Interrupt
PC = TOS
GIE = 1

TABLE 37-18: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Standard Operating Conditions (unless otherwise stated)
Operating Temperature -40°C ≤ TA ≤ +125°C

Param. No.	Sym.	Characteristic		Min.	Typ†	Max.	Units	Conditions
40*	TT0H	T0CKI High Pulse Width	No Prescaler	0.5 TCY + 20	—	—	ns	
			With Prescaler	10	—	—	ns	
41*	TT0L	T0CKI Low Pulse Width	No Prescaler	0.5 TCY + 20	—	—	ns	
			With Prescaler	10	—	—	ns	
42*	TT0P	T0CKI Period		Greater of: 20 or (TCY + 40)/N	—	—	ns	N = prescale value
45*	TT1H	T1CKI High Time	Synchronous, No Prescaler	0.5 TCY + 20	—	—	ns	
			Synchronous, with Prescaler	15	—	—	ns	
			Asynchronous	30	—	—	ns	
46*	TT1L	T1CKI Low Time	Synchronous, No Prescaler	0.5 TCY + 20	—	—	ns	
			Synchronous, with Prescaler	15	—	—	ns	
			Asynchronous	30	—	—	ns	
47*	TT1P	T1CKI Input Period	Synchronous	Greater of: 30 or (TCY + 40)/N	—	—	ns	N = prescale value
			Asynchronous	60	—	—	ns	
49*	TCKEZTMR1	Delay from External Clock Edge to Timer Increment		2 TOSC	—	7 TOSC	—	Timers in Sync mode

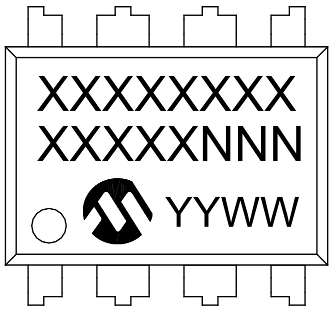
* These parameters are characterized but not tested.

† Data in “Typ” column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

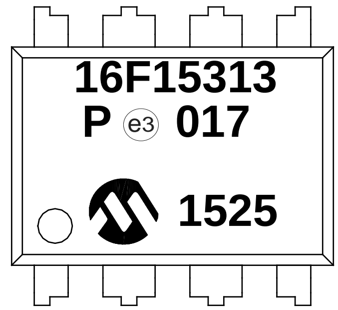
40.0 PACKAGING INFORMATION

40.1 Package Marking Information

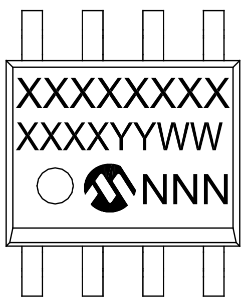
8-Lead PDIP (300 mil)



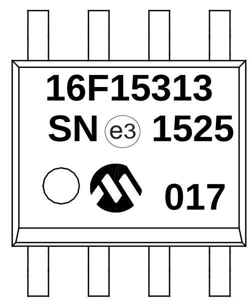
Example



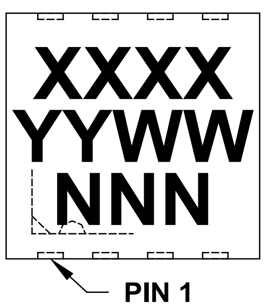
8-Lead SOIC (3.90 mm)



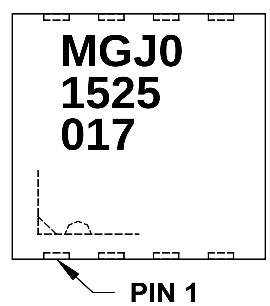
Example



8-Lead UDFN (3x3x0.9 mm)



Example

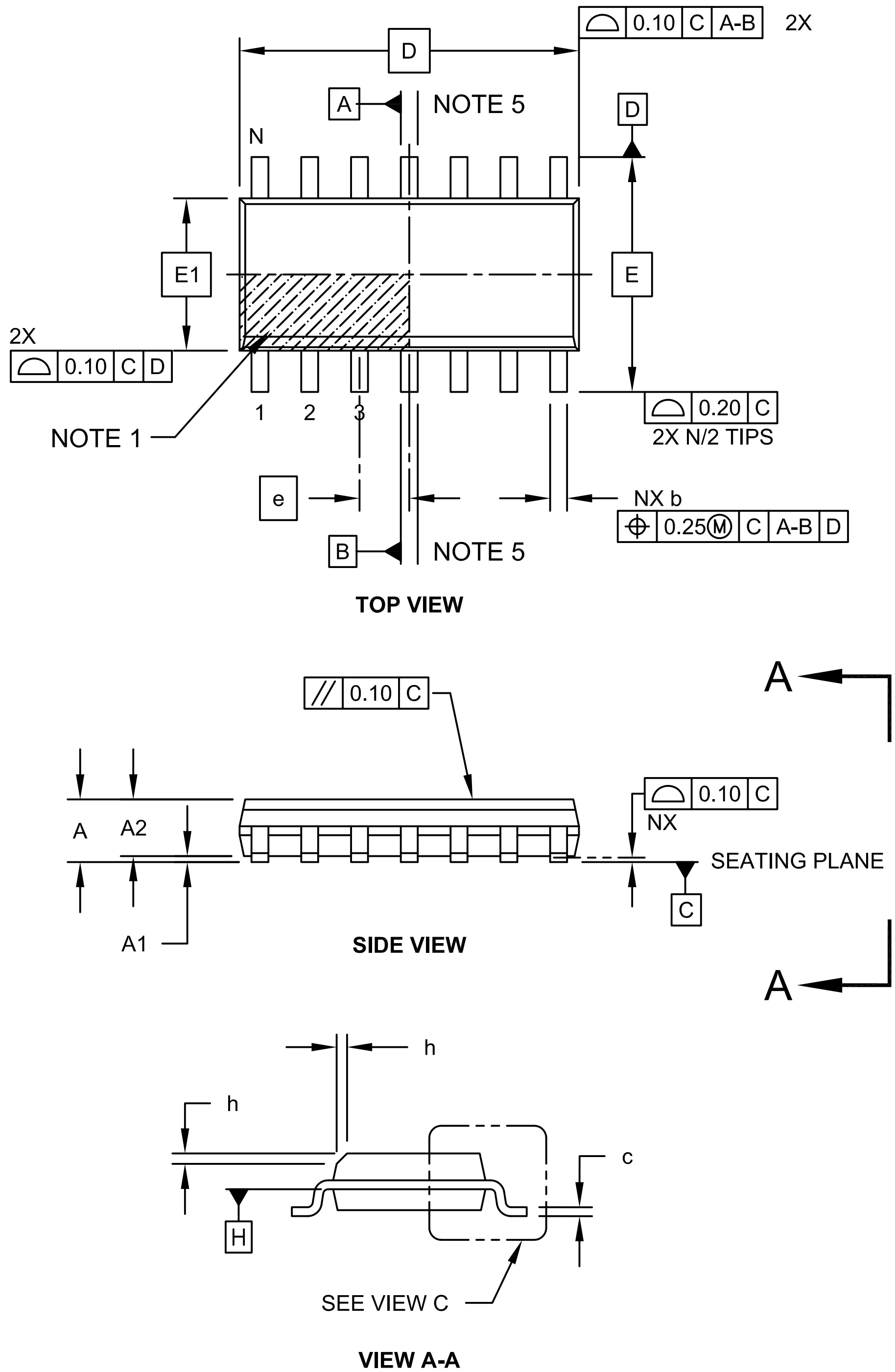


Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

14-Lead Plastic Small Outline (SL) - Narrow, 3.90 mm Body [SOIC]

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing No. C04-065C Sheet 1 of 2